

Features

- BV_{CEO} > 70V
- BV_{CBO} > 70V
- I_C = 2A High Continuous Current
- h_{FE} > 400 for High Gain @ 0.5A
- Complementary PNP Type: FZT792A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The FZT692BQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Package: SOT223
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020

С

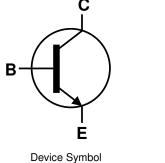
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)

Applications

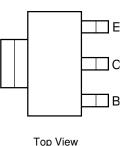
- Darlington replacements
- Relay and solenoid drivers
- DC-DC converters



Top View



SOT223 (Type DN)



Pin-Out

Ordering Information (Note 4)

Part Number	Compliance	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
Fait Nulliber	Compliance Fackage Marking	neel Size (Inches)	Tape width (mm)	Qty.	Carrier		
FZT692BQTA	Automotive	SOT223 (Type DN)	FZT692B	7	12	1,000	Reel

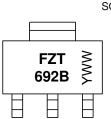
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



SOT223 (Type DN)

 $\begin{array}{l} \mathsf{FZT} \ 692\mathsf{B} = \mathsf{Product} \ \mathsf{Type} \ \mathsf{Marking} \ \mathsf{Code} \\ \mathsf{YWW} = \mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \mathsf{Y} \ \mathsf{or} \ \overline{\mathsf{Y}} = \mathsf{Last} \ \mathsf{Digit} \ \mathsf{of} \ \mathsf{Year} \ (\mathsf{ex:} \ \mathsf{2} = \mathsf{2022}) \\ \mathsf{WW} \ \mathsf{or} \ \overline{\mathsf{WW}} = \mathsf{Week} \ \mathsf{Code} \ (\mathsf{01} \ \mathsf{to} \ \mathsf{53}) \end{array}$



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	Vсво	70	V
Collector-Emitter Voltage	VCEO	70	V
Emitter-Base Voltage	VEBO	7	V
Continuous Collector Current	lc	2	А
Peak Pulse Current	Ісм	5	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
	(Note 5)		3		
Dewer Dissignation	(Note 6)	D-	2	w	
Power Dissipation	(Note 7)	PD	1.6	vv	
	(Note 8)		1.2	1	
	(Note 5)		41.7		
Thermal Desistance Junction to Ambient	(Note 6)		62.5		
Thermal Resistance, Junction to Ambient	(Note 7)	Reja	78.1	°C/W	
	(Note 8)		104		
Thermal Resistance Junction to Lead	(Note 9)	Rejl	12.9		
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

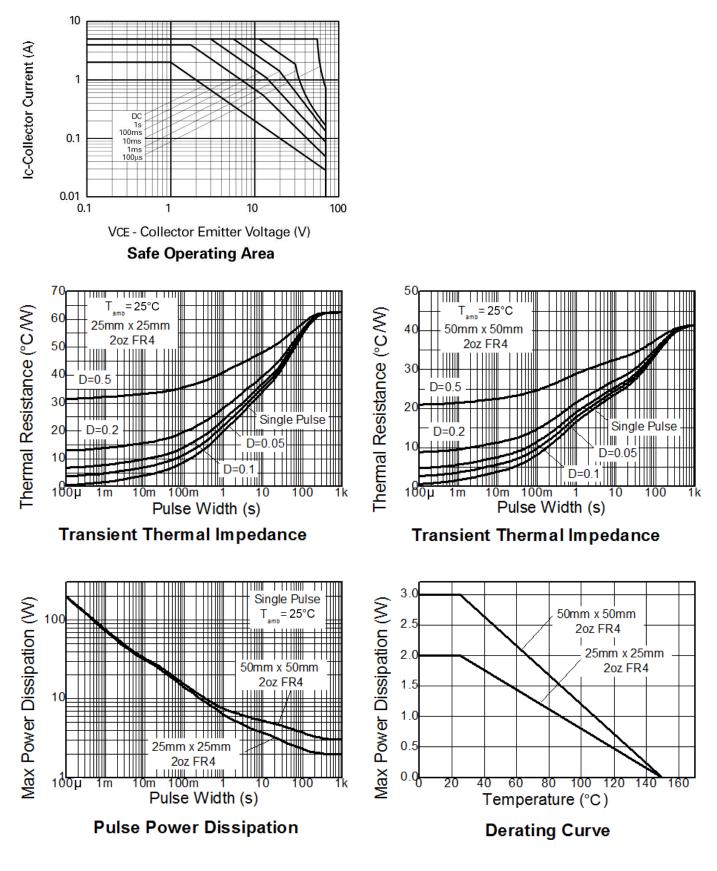
ESD Ratings (Note 10)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

 5. For a device mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
7. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
8. Same as Note 5, except the device is mounted on minimum recommended pad layout.
9. Thermal resistance from junction to solder-point (at the end of the collector lead).
10. Refer to JEDEC specification JESD22-A114 and JESD22-A115. Notes:



Thermal Characteristics and Derating Information





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

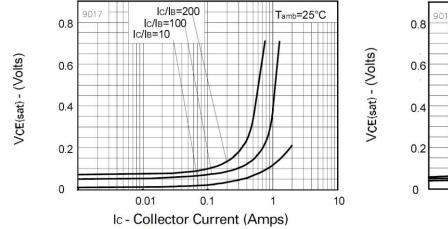
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	70	. yp		V	$I_{\rm C} = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 11)	BVCEO	70	_	_	V	$I_{C} = 10 \text{mA}$
Emitter-Base Breakdown Voltage	BVEBO	7	_	_	V	I _E = 100μA
Collector-Base Cut-Off Current	ICBO	_	_	50	nA	V _{CB} = 55V
Collector-Emitter Cut-Off Current	ICES	—	_	50	nA	V _{CE} = 55V
Emitter Cut-Off Current	IEBO	—	—	20	nA	V _{EB} = 6V
DC Current Gain (Note 11)	hFE	500 400 150			_	$\label{eq:IC} \begin{split} I_{C} &= 100 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 500 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 1 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 11)	VCE(sat)			150 500 500	mV	$\label{eq:IC} \begin{array}{l} IC = 0.1A, \ IB = 0.5mA \\ IC = 1A, \ IB = 10mA \\ IC = 2A, \ IB = 200mA \end{array}$
Base-Emitter Saturation Voltage (Note 11)	VBE(sat)	_	—	0.9	V	Ic = 1A, I _B = 10mA
Base-Emitter Turn-On Voltage (Note 11)	VBE(on)	_	—	0.9	V	Ic = 1A, Vce = 2V
Input Capacitance	Cibo	_	200	_	pF	V _{EB} = 0.5V, f = 1MHz
Output Capacitance	Cobo	_	12		pF	V _{CB} = 10V, f = 1MHz
Current Gain-Bandwidth Product	f⊤	150	—	_	MHz	V _{CE} = 5V, I _C = 50mA, f = 50MHz
Turn-On Time	ton	_	46	_	ns	V _{CC} = 10V, I _C = 500mA
Turn-Off Time	toff	_	1440	—	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$

Note: 11. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

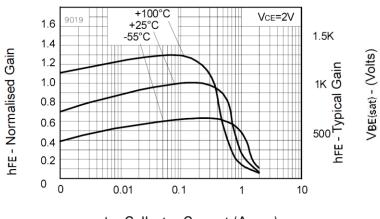


FZT692BQ

Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

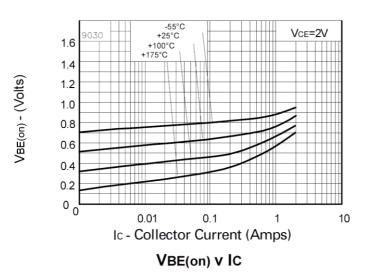


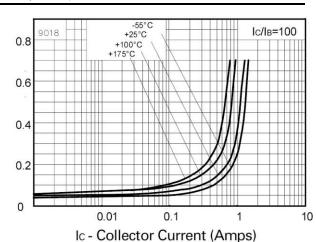




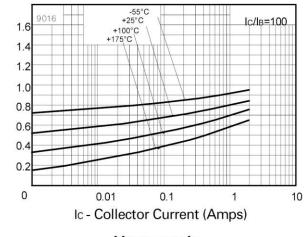
Ic - Collector Current (Amps)







VCE(sat) v IC

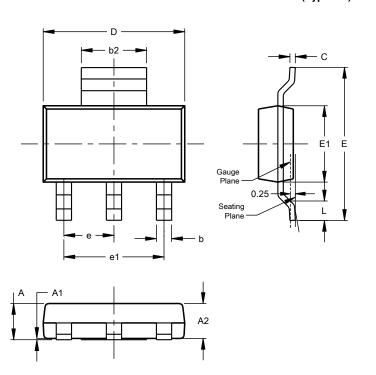


VBE(sat) v IC



Package Outline Dimensions

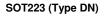
Please see http://www.diodes.com/package-outlines.html for the latest version.

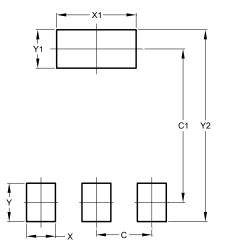


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SC	SOT223 (Type DN)					
Dim	Min	Max	Тур			
Α		1.70				
A1	0.01	0.15				
A2	1.50	1.68	1.60			
b	0.60	0.80	0.70			
b2	2.90	3.10				
С	0.20	0.32				
D	6.30	6.70				
E	6.70	7.30				
E1	3.30	3.70				
е			2.30			
e1			4.60			
L	0.85					
All [All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00



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